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16-bit D-type Transparent Latches with 3-state Outputs



ADE-205-121B(Z)

3rd Edition December 1996

Description

The HD74LVC16373A has sixteen D type latches with three state outputs in a 48 pin package. When the latch enable input is high, the Q outputs will follow the D inputs. When the latch enable goes low, data at the D inputs will be retained at the outputs until latch enable returns high again. When a high logic level is applied to the output control input $(1\overline{G}, 2\overline{G})$, all outputs go to a high impedance state, regardless of what signals are present at the other inputs and the state of the storage elements. Low voltage and high speed operation is suitable at the battery drive product (note type personal computer) and low power consumption extends the life of a battery for long time operation.

Features

- $V_{cc} = 2.0 \text{ V to } 5.5 \text{ V}$
- All inputs V_{H} (Max.) = 5.5 V (@ V_{CC} = 0 V to 5.5 V)
- All outputs V_{OUT} (Max.) = 5.5 V (@ V_{CC} = 0 V or output off state)
- Typical V_{OL} ground bounce < 0.8 V (@ V_{CC} = 3.3 V, Ta = 25°C)
- Typical V_{OH} undershoot > 2.0 V (@ V_{CC} = 3.3 V, Ta = 25°C)
- High output current ± 24 mA (@V_{cc} = 3.0 V to 5.5 V)

Function Table

Inputs

G	LE	D	Output Q
Н	X	X	Z
L	Н	L	L
L	Н	Н	Н
L	L	X	Q_{\circ}

H: High level

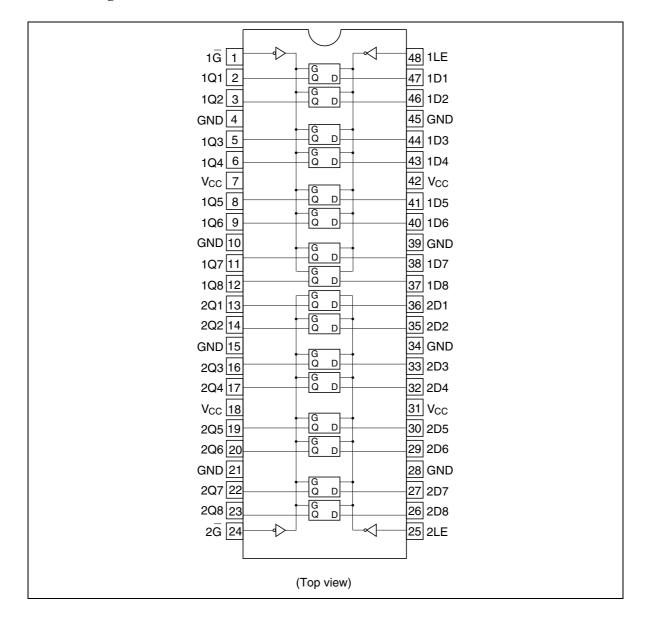
L: Low level

X: Immaterial

Z: High impedance

 ${\bf Q}_{\!\scriptscriptstyle 0}$: Level of ${\bf Q}$ before the indicated steady input conditions were established.

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V _{cc}	-0.5 to 6.0	V	
Input diode current	I _{IK}	-50	mA	V ₁ = -0.5 V
Input voltage	V _I	-0.5 to 6.0	V	
Output diode current	I _{ok}	-50	mA	V _o = -0.5 V
		50	mA	$V_{o} = V_{cc} + 0.5 \text{ V}$
Output voltage	V _o	–0.5 to $V_{\rm cc}$ +0.5	V	Output "H" or "L"
		-0.5 to 6.0	V	Output "Z" or V _{cc} :OFF
Output current	Io	±50	mA	
V _{cc} , GND current / pin	I _{CC} or I _{GND}	100	mA	
Storage temperature	Tstg	-65 to +150	°C	

Note: The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V _{cc}	1.5 to 5.5	V	Data hold
		2.0 to 5.5	V	At operation
Input / output voltage	V,	0 to 5.5	V	G, LE, D
	V _o	0 to V _{cc}	V	Output "H" or "L"
		0 to 5.5	V	Output "Z" or V _{cc} :OFF
Operating temperature	Та	-40 to 85	°C	
Output current	I _{OH}	-12	mA	V _{cc} = 2.7 V
		-24 *2	mA	$V_{cc} = 3.0 \text{ V to } 5.5 \text{ V}$
	I _{OL}	12	mA	V _{cc} = 2.7 V
		24*2	mA	V _{cc} = 3.0 V to 5.5 V
Input rise / fall time *1	t _r , t _r	10	ns/V	

Notes: 1. This item guarantees maximum limit when one input switches.

Waveform : Refer to test circuit of switching characteristics.

2. duty cycle $\leq 50\%$

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Electrical Characteristics

Ta = -40 to 85°C

Item	Symbol	$V_{cc}(V)$	Min	Max	Unit	Test Conditions
Input voltage	V _{IH}	2.7 to 3.6	2.0	_	V	
		4.5 to 5.5	V _{cc} ×0.7	_	V	_
	V _{IL}	2.7 to 3.6	_	0.8	V	
		4.5 to 5.5	_	V _{cc} ×0.3	V	_
Output voltage	V _{OH}	2.7 to 5.5	V _{cc} -0.2	_	V	$I_{OH} = -100 \mu A$
		2.7	2.2	_	٧	$I_{OH} = -12 \text{ mA}$
		3.0	2.4	_	٧	_
		3.0	2.2	_	V	I _{OH} = -24 mA
		4.5	3.8	_	٧	_
	V _{OL}	2.7 to 5.5	_	0.2	V	I _{oL} = 100 μA
		2.7	_	0.4	٧	I _{oL} = 12 mA
		3.0	_	0.55	٧	I _{oL} = 24 mA
		4.5	_	0.55	٧	_
Input current	I _{IN}	0 to 5.5	_	±5.0	μΑ	V _{IN} = 5.5 V or GND
Off state output current	l _{oz}	2.7 to 5.5	_	±5.0	μΑ	$V_{IN} = V_{CC}$, GND $V_{OUT} = 5.5$ V or GND
Output leak current	I _{OFF}	0	_	20	μΑ	$V_{IN} / V_{OUT} = 5.5 V$
Quiescent supply current	I _{cc}	2.7 to 3.6	_	±20	μΑ	$V_{IN} / V_{OUT} = 3.6 \text{ to } 5.5 \text{ V}$
		2.7 to 5.5	_	20	μΑ	$V_{IN} = V_{CC}$ or GND
	ΔI_{cc}	3.0 to 3.6	_	500	μА	V_{IN} = one input at $(V_{\text{CC}}$ -0.6)V, other inputs at V_{CC} or GND

Switching Characteristics

		Ta = −40 to 85°C						
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Unit	From (Input)	To (Output)
Propagation delay time	t _{PLH}	2.7	_	_	7.7	ns	D	Q
	$t_{_{PHL}}$	3.3±0.3	1.5	_	7.0	ns	_	
		5.0±0.5	_	_	5.5	ns	_	
	t _{PLH}	2.7	_	_	8.0	ns	LE	Q
	$t_{_{PHL}}$	3.3±0.3	2.0	_	7.0	ns	_	
		5.0±0.5	_	_	5.5	ns	=	
Output enable time	t _{zн}	2.7	_	_	8.0	ns	G	Q
	$\mathbf{t}_{_{\mathrm{ZL}}}$	3.3±0.3	1.5	_	7.0	ns	_	
		5.0±0.5	_	_	6.0	ns	_	
Output disable time	t _{HZ}	2.7	_	_	8.0	ns	G	Q
	$\mathbf{t}_{\scriptscriptstyle{LZ}}$	3.3±0.3	1.5	_	7.0	ns	_	
		5.0±0.5	_	_	6.0	ns	=	
Setup time	t _{su}	2.7	2.0	_	_	ns		
		3.3±0.3	2.0	_	_	ns	_	
		5.0±0.5	2.0	_	_	ns	=	
Hold time	t _h	2.7	1.5	_	_	ns		
		3.3±0.3	1.5	_	_	ns	_	
		5.0±0.5	1.5	_	_	ns	=	
Pulse width	t _w	2.7	3.0	_	_	ns		
		3.3±0.3	3.0	_	_	ns	_	
		5.0±0.5	3.0	_	_	ns	_	
Between output pins skew '1	t _{oslh}	2.7	_	_	_	ns		
	$\mathbf{t}_{\scriptscriptstyle{OSHL}}$	3.3±0.3	_	_	1.0	ns	_	
		5.0±0.5	_	_	1.0	ns	_	
Input capacitance	C _{IN}	2.7	_	3.0	_	pF		

Note: 1. This parameter is characterized but not tested.

 $\mathsf{tos}_{_{\mathsf{LH}}} = \mathsf{I} \; \mathsf{t}_{_{\mathsf{PLHm}}} - \mathsf{t}_{_{\mathsf{PLHn}}} \, \mathsf{I}, \, \mathsf{tos}_{_{\mathsf{HL}}} = \mathsf{I} \; \mathsf{t}_{_{\mathsf{PHLm}}} - \mathsf{t}_{_{\mathsf{PHLn}}} \, \mathsf{I}$

 C_{\circ}

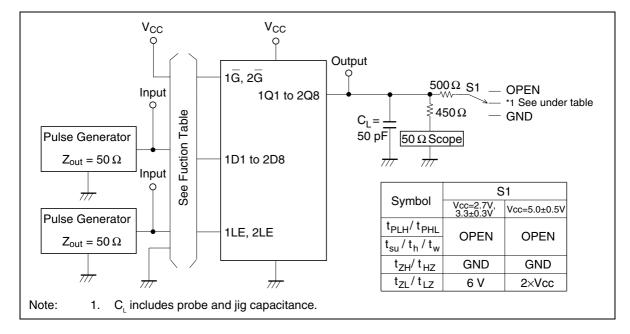
2.7

Output capacitance

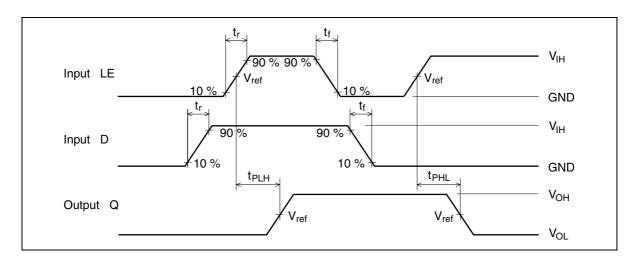
15.0

pF

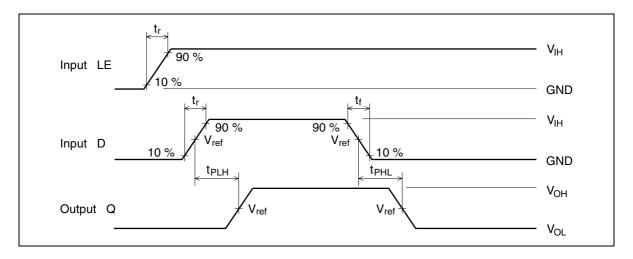
Test Circuit



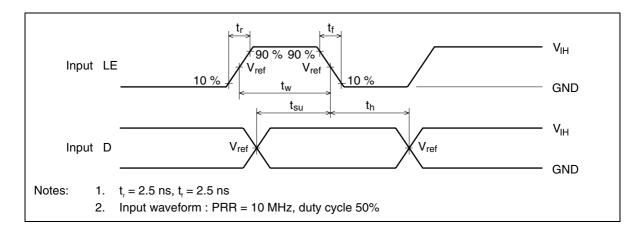
Waveforms - 1



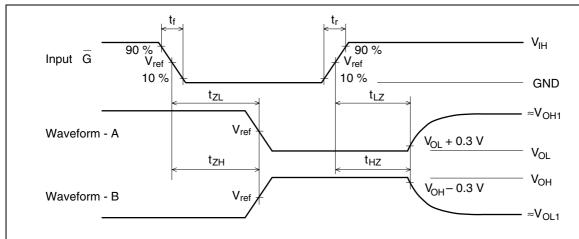
Waveforms - 2



Waveforms - 3



Waveforms - 4

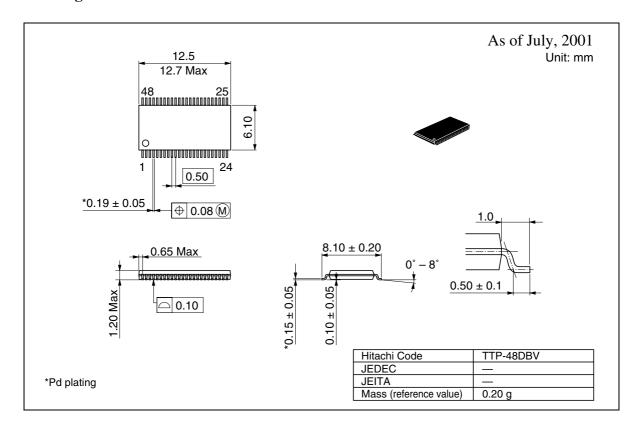


TEST	Vcc=2.7V, 3.3±0.3V	Vcc=5.0±0.5V
V_{IH}	2.7 V	Vcc
V_{ref}	1.5 V	50%Vcc
V _{OH1}	3 V	Vcc
V _{OL1}	GND	GND

Notes:

- 1. $t_r = 2.5 \text{ ns}, t_r = 2.5 \text{ ns}$
- 2. Input waveform: PRR = 10 MHz, duty cycle 50%
- 3. Waveform A shows input conditions such that the output is "L" level when enable by the output control.
- 4. Waveform B shows input conditions such that the output is "H" level when enable by the output control.

Package Dimensions



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